MGV252010R33M-10

PHYSICAL DIMENSIONS:

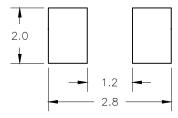
A 2.50 ± 0.20

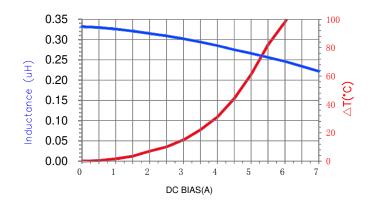
B 2.00 ± 0.20

C 1.00 Max.

 $D = 0.60 \pm 0.30$

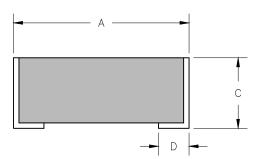
LAND PATTERNS FOR REFLOW SOLDERING



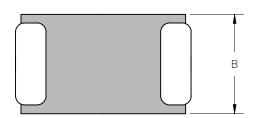


ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	0.264	0.33	0.396
DCR (Ω)		0.021	0.026
Saturation Current Isat (A)		6.10	5.50
Heating Current Irms (A)		4.40	4.00







NOTES:

- 1. OPERATING TEMPERATURE RANGE: -40° C $\sim +125^{\circ}$ C.
- 2. STORAGE TEMPERATURE RANGE: -40° C $\sim +125^{\circ}$ C.
- 3. Isat MEANS THAT MAX DC CURRENT WILL CAUSE APPROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 4. Irms MEANS THAT MAX DC CURRENT WILL CAUSE COIL TEMPERATURE RISE APPROXIMATELY 40°C AT AMBIENT 25±5°C.

	DIMENSIONS ARE IN mm.			This print is the property of Lair Tech. and is loaned in confidence subject to return upon request c with the understanding that no copies shall be made without the written consent of Laird Tech. Al rights to design or invention are reserved.	Laird				
				PROJECT/PART NUMBER:	TF	EV	PART TY		DRAWN BY:
				MGV252010R33M-10		Α		OKE CTOR	QIU
				DATE: 09/20/17	SCALE: NTS		ז	SHEET:	
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